

Surface Mount RF Transformer

50Ω

10 to 1900 MHz

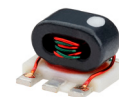
TCM4-19+

Features

- wide bandwidth, 10 to 1900 MHz
- balanced transmission line with secondary center tap
- plastic base with solder plated leads
- aqueous washable

Applications

- PCS
- cellular



Generic photo used for illustration purposes only

CASE STYLE: DB714

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost	
Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

Electrical Specifications

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (secondary/primary)			4		Ohm
Frequency Range		10		1900	MHz
Insertion Loss*	10 - 1900		3		dB
	20 - 1000		2		
	30 - 700		1		
Phase Unbalance	30 - 700		4		Deg.
	20 - 1000		6		
Amplitude Unbalance	30 - 700		0.3		dB
	20 - 1000		0.5		

* Insertion Loss is referenced to mid-band loss, 1.0 dB typ.
Measure back to back

Maximum Ratings

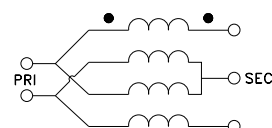
Parameter	Ratings
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

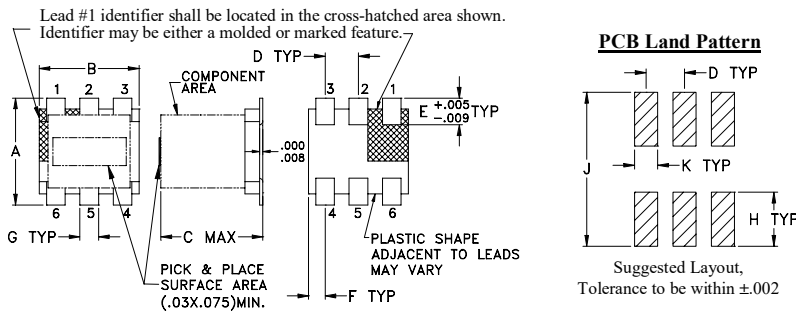
Pin Connections

Function	Pin Number
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	3
SECONDARY	1
SECONDARY CT	2
NOT USED	5

Config. H



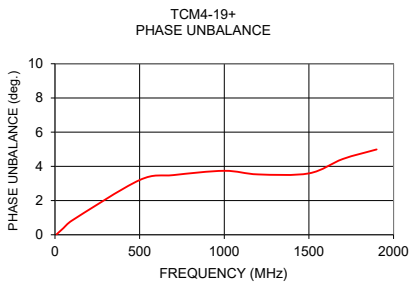
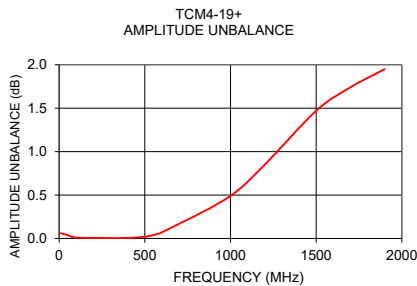
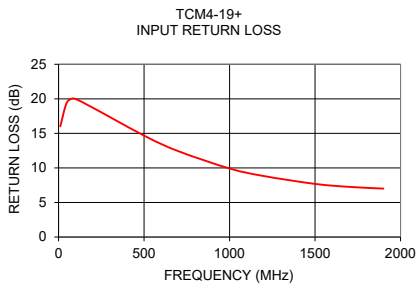
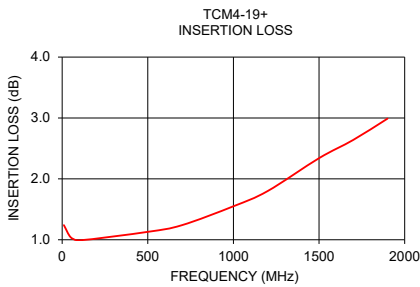
Outline Drawing



Outline Dimensions (inch mm)

A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.15	

Frequency (MHz)	Insertion Loss (dB)	Input R. Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (Deg.)
10	1.24	16.03	0.06	0.03
50	1.04	19.54	0.04	0.39
100	0.99	19.98	0.01	0.83
500	1.13	14.68	0.02	3.20
700	1.24	12.43	0.17	3.49
1000	1.55	9.92	0.49	3.74
1200	1.80	8.83	0.85	3.53
1500	2.34	7.69	1.47	3.59
1700	2.64	7.26	1.74	4.43
1900	2.99	7.01	1.95	4.99



Additional Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

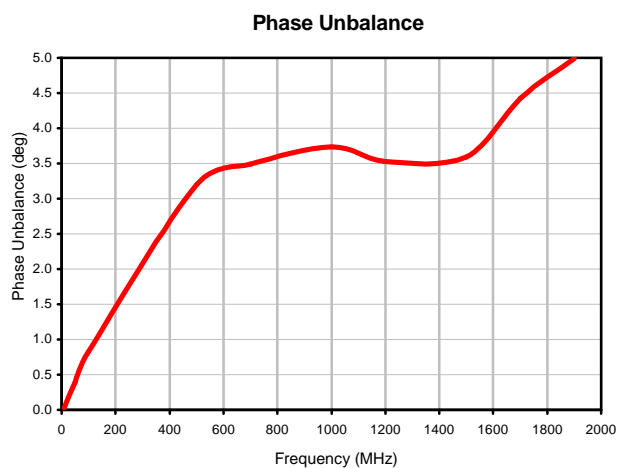
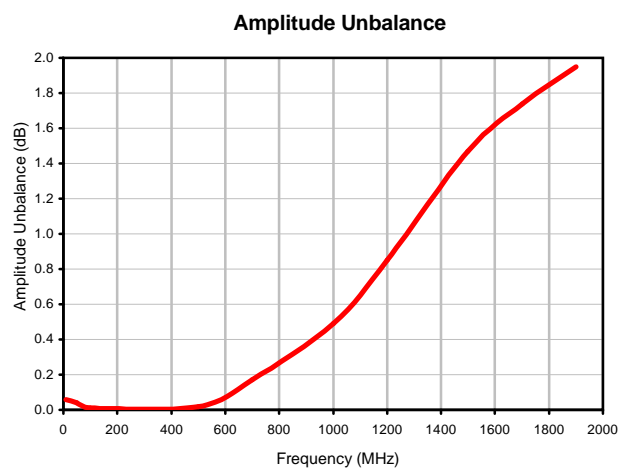
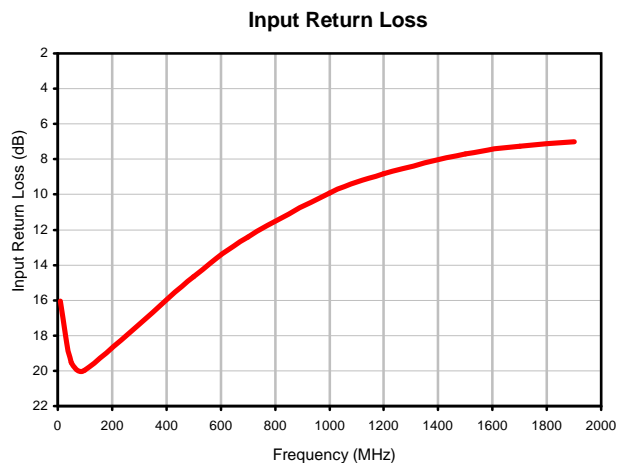
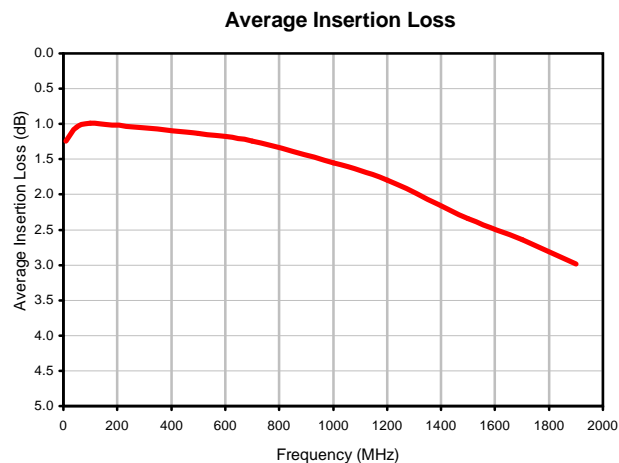
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Typical Performance Data

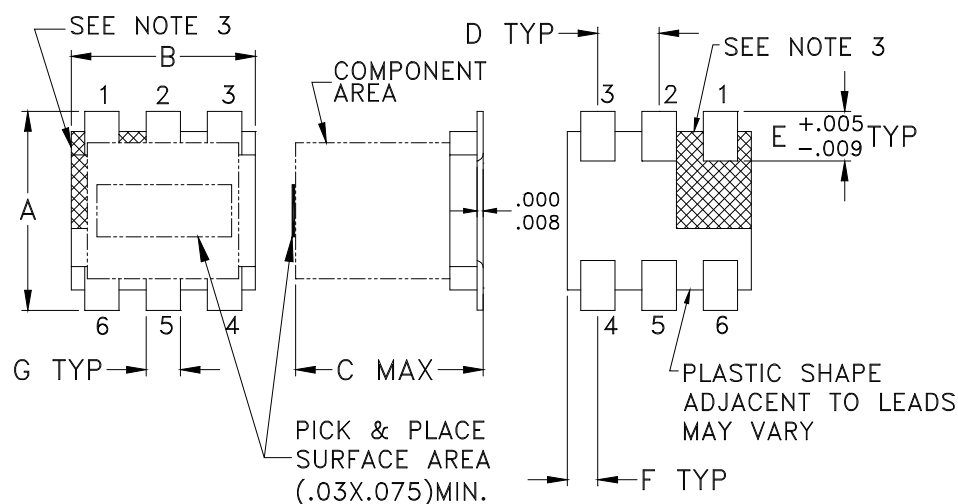
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg)
10	1.24	16.03	0.06	0.03
50	1.04	19.54	0.04	0.39
100	0.99	19.98	0.01	0.83
500	1.13	14.68	0.02	3.20
700	1.24	12.43	0.17	3.49
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1500	2.34	7.69	1.47	3.59
1700	2.64	7.26	1.74	4.43
1900	2.99	7.01	1.95	4.99

Typical Performance Curves

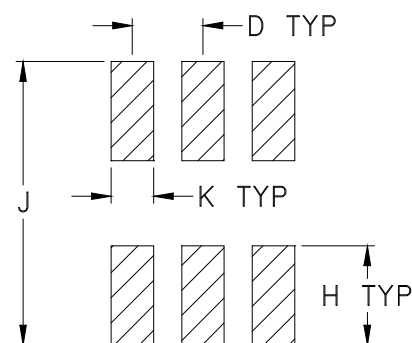


Outline Dimensions

DB714



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB714	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Lead #1 identifier shall be located in the cross-hatched area shown.
Identifier may be either a molded or marked feature.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

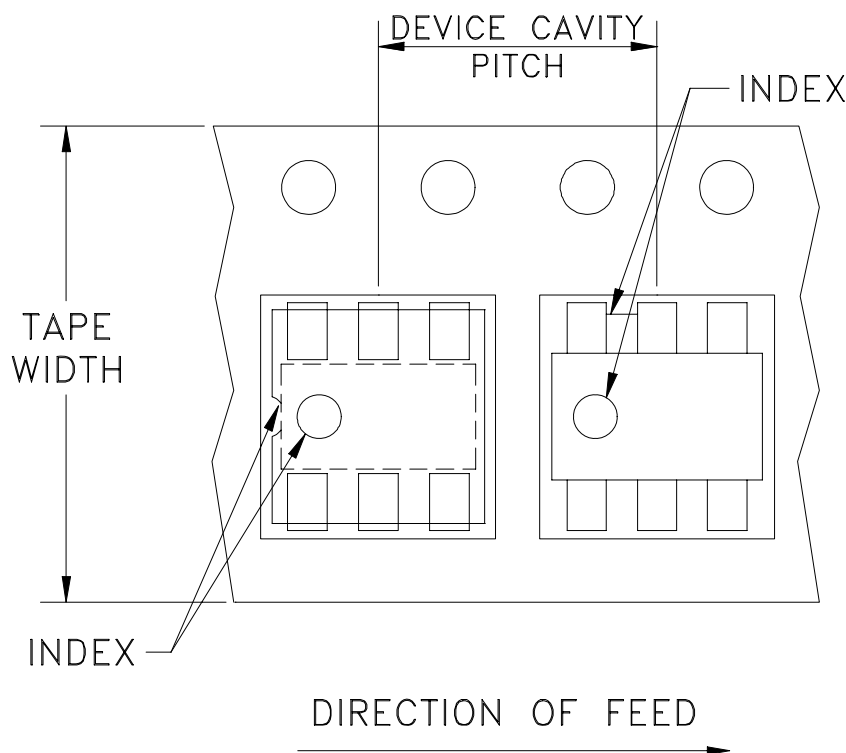


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



INTERNET <http://www.minicircuits.com>

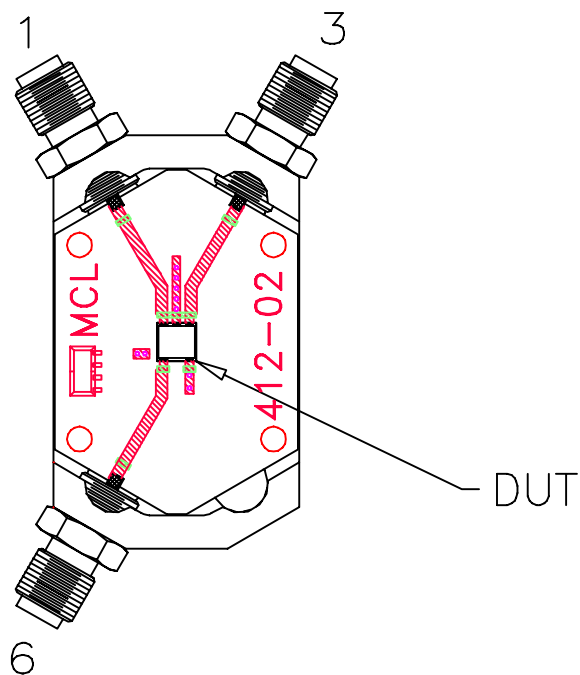
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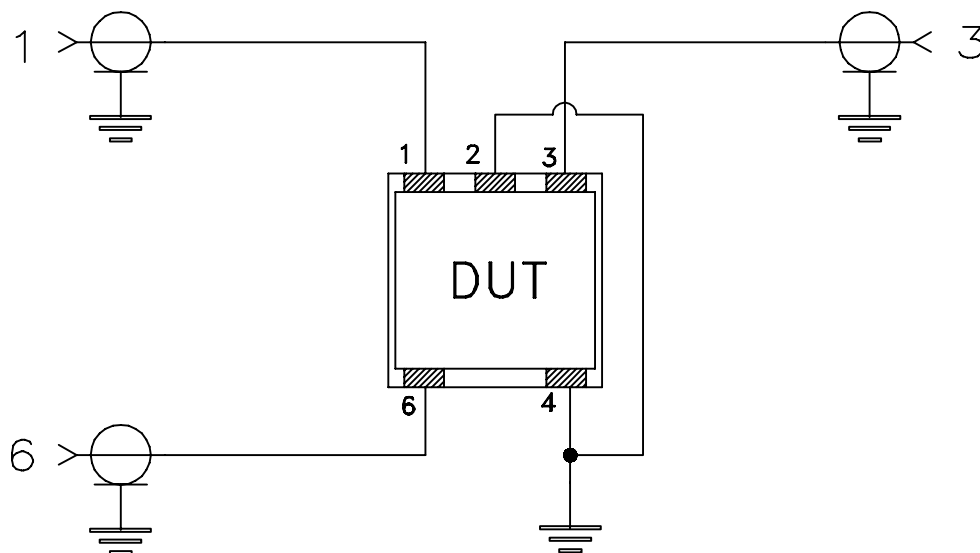
Mini-Circuits ISO 9001 & ISO 14001 Certified

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT




TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215